

26176CTE

Low Height, Low Profile Twisted Fin, Surface Mount Heat Sinks for D2 Pak (TO-263) semiconductors.

Product Specifications	
Material	Copper
Finish	Matte Tin
Device Cooled	TO-263
Thermal Resistance	11.00
Length (mm)	19.38
Width (mm)	25.40
Height (mm)	11.43

